

SPECIFICATION

• Supplier : Samsung electro-mechanics • Part Number : CL21C270GBANNNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 27pF, 50V, ±2%, C0G, 0805

A. Samsung Part Number

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① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0805 (inch code)	L: 2.0 ± 0.1 mm	W: 1.25 ± 0.1 mm
3 Dielectric	C0G	8 Inner electrode	Ni
4 Capacitance	27 pF	Termination	Cu
⑤ Capacitance	± 2 %	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Normal
6 Rated Voltag	je 50 V	10 Special	Reserved for future use
7 Thickness	0.65 ± 0.1 mm	11) Packaging	Cardboard Type, 7" reel

B. Samsung Reliablility Test and Judgement condition

	Performance	Test condition	
Capacitance	Within specified tolerance	1Mb±10% 0.5~5Vrms	
Q	940 min		
Insulation	10,000Mohm or 500Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.	
Resistance	Whichever is Smaller		
Appearance	No abnormal exterior appearance	Microscope (×10)	
Withstanding	No dielectric breakdown or	300% of the rated voltage	
Voltage	mechanical breakdown		
Temperature	COG		
Characterisitcs	(From -55℃ to 125℃, Capacitance change shoud be within ±30PPM/℃)		
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.	
of Termination	terminal electrode		
Bending Strength	Capacitance change :	Bending to the limit (1mm)	
	within ±5% or ±0.5pF whichever is larger	with 1.0mm/sec.	
Solderability	More than 95% of terminal surface	1) Sn63Pb37 solder	
	is to be soldered newly	235±5℃, 5±0.5sec.	
		2) SnAg3.0Cu0.5 solder	
		245±5℃, 3±0.3sec.	
		(preheating : 80~120 ℃ for 10~30sec.)	
Resistance to	Capacitance change :	Solder pot : 270±5 ℃, 10±1sec.	
Soldering heat	within ±2.5% or ±0.25pF whichever is larger		
	Tan δ, IR : initial spec.		

	Performance	Test condition
Vibration Test	Capacitance change :	Amplitude: 1.5mm
	within ±2.5% or ±0.25pF whichever is larger	From 10Hz to 55Hz (return : 1min.)
	Tan δ, IR : initial spec.	2hours × 3 direction (x, y, z)
Humidity Capacitance change :		40±2℃, 90~95%RH, 500+12/-0hrs
	within ±5% or ±0.5pF whichever is larger	
	Q: 342.5 min	
	IR: 1000Mohm or 50Mohm $\cdot \mu$ F	
	Whichever is Smaller	
Moisture	Capacitance change :	With rated voltage
Resistance	within ±7.5% or ±0.75pF whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs
	Q: 190 min	
	IR: 500Mohm or 25Mohm · μF	
	Whichever is Smaller	
High Temperature	Capacitance change :	With 200% of the rated voltage
Resistance	within ±3% or ±0.3pF whichever is larger	Max. operating temperature
	Q: 342.5 min	1000+48/-0hrs
	IR: 1000Mohm or 50Mohm · μF	
	Whichever is Smaller	
Temperature	Capacitance change :	1 cycle condition
Cycling	within ±2.5% or ±0.25pF whichever is larger	Min. operating temperatul → 25 °C
	Tan δ, IR : initial spec.	→ Max. operating temperature → 25°C
		5 cycle test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 250±5 °C, 6sec. Max)

 $^{^{\}star}$ For the more detail Specification, Please refer to the Samsung MLCC catalogue.

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1812J1K00473KXT 1812J2K00680JCT 1812J4K00102MXT 1812J5000102JCT 1812J5000103JCT 1812J5000682JCT NIN-FB391JTRF

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CGA2B2C0G1H040C CGA2B2C0G1H050C CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H151J CGA2B2C0G1H1R5C

CGA2B2C0G1H2R2C CGA2B2C0G1H3R3C CGA2B2C0G1H680J CGA2B2C0G1H6R8D CGA2B2X8R1H221K CGA2B2X8R1H472K

CGA3E1X7R1C474K